

- Any frequency between 220 MHz and 625 MHz accurate to 6 decimal places
- LVPECL and LVDS output signaling types
- 0.6ps RMS phase jitter (random) over 12 kHz to 20 MHz bandwidth
- Frequency stability as low as ±10 ppm
- Industrial and extended commercial temperature ranges
- Industry-standard packages: 3.2x2.5, 5.0x3.2 and 7.0x5.0 mmxmm
- For frequencies lower than 220 MHz, refer to SiT9121 datasheet

Applications

- 10GB Ethernet, SONET, SATA, SAS, Fibre Channel, PCI-Express
- Telecom, networking, instrumentation, storage, servers



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Electrical Characteristics

Parameter and Conditions	Symbol	Min.	Тур.	Max.	Unit	Condition
	L	VPECL an	d LVDS, C	Common El	lectrical (Characteristics
Supply Voltage	Vdd	2.97	3.3	3.63	V	
		2.25	2.5	2.75	V	
		2.25	-	3.63	V	Termination schemes in Figures 1 and 2 - XX ordering code
Output Frequency Range	f	220	-	625	MHz	
Frequency Stability	F_stab	-10	-	+10	ppm	
		-20	-	+20	ppm	Inclusive of initial tolerance, operating temperature, rated power
		-25	-	+25	ppm	supply voltage, and load variations
		-50	-	+50	ppm	
First Year Aging	F_aging1	-2	-	+2	ppm	25°C
10-year Aging	F_aging10	-5	-	+5	ppm	25°C
	-	-40	-	+85	°C	Industrial
Operating Temperature Range	T_use	-20	-	+70	°C	Extended Commercial
Input Voltage High	VIH	70%	-	-	Vdd	Pin 1. OE or ST
Input Voltage Low	VIL	_	_	30%	Vdd	Pin 1. OE or ST
		_	100	250	kΩ	Pin 1, OE logic high or logic low, or ST logic high
Input Pull-up Impedance	Z_in	2	_		MΩ	Pin 1, ST logic low
Start un Time	Totort					Measured from the time Vdd reaches its rated minimum value.
Start-up Time	T_start	_	6	10	ms	
Resume Time	T_resume	-	6	10	ms	In Standby mode, measured from the time \overline{ST} pin crosses 50% threshold.
Duty Cycle	DC	45	-	55	%	Contact SiTime for tighter duty cycle
		Ľ	/PECL, DO	C and AC C	Character	istics
Current Consumption	ldd	-	61	69	mA	Excluding Load Termination Current, Vdd = 3.3V or 2.5V
OE Disable Supply Current	I_OE	-	-	35	mA	OE = Low
Output Disable Leakage Current	I_leak	-	-	1	μA	OE = Low
Standby Current	I_std	-	-	100	μA	ST = Low, for all Vdds
Maximum Output Current	I_driver	-	-	30	mA	Maximum average current drawn from OUT+ or OUT-
Output High Voltage	VOH	Vdd-1.1	-	Vdd-0.7	V	See Figure 1(a)
Output Low Voltage	VOL	Vdd-1.9	-	Vdd-1.5	V	See Figure 1(a)
Output Differential Voltage Swing	V_Swing	1.2	1.6	2.0	V	See Figure 1(b)
Rise/Fall Time	Tr, Tf	-	300	500	ps	20% to 80%, see Figure 1(a)
OE Enable/Disable Time	T_oe	-	-	115	ns	f = 220 MHz - For other frequencies, T_oe = 100ns + 3 period
RMS Period Jitter	T_jitt	-	1.2	1.7	ps	f = 266 MHz, VDD = 3.3V or 2.5V
		-	1.2	1.7	ps	f = 312.5 MHz, VDD = 3.3V or 2.5V
		-	1.2	1.7	ps	f = 622.08 MHz, VDD = 3.3V or 2.5V
RMS Phase Jitter (random)	T_phj	-	0.6	0.85	ps	f = 312.5 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdds
	I		LVDS, DC	and AC Ch	naracteris	
Current Consumption	ldd	-	47	55	mA	Excluding Load Termination Current, Vdd = 3.3V or 2.5V
OE Disable Supply Current	I_OE	-	-	35	mA	OE = Low
Differential Output Voltage	utput Voltage VOD 250 350 450 mV See Figure 2			See Figure 2		

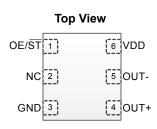


Electrical Characteristics (continued)

Parameter and Conditions	Symbol	Min.	Тур.	Max.	Unit	Condition		
LVDS, DC and AC Characteristics (continued)								
Output Disable Leakage Current I_leak – – 1 μA OE = Low								
Standby Current	I_std	-	-	100	μΑ	ST = Low, for all Vdds		
VOD Magnitude Change	ΔVOD	-	-	50	mV	See Figure 2		
Offset Voltage	VOS	1.125	1.2	1.375	V	See Figure 2		
VOS Magnitude Change	ΔVOS	-	-	50	mV	See Figure 2		
Rise/Fall Time	Tr, Tf	-	495	600	ps	20% to 80%, see Figure 2		
OE Enable/Disable Time	T_oe	-	-	115	ns	f = 220 MHz - For other frequencies, T_oe = 100ns + 3 period		
RMS Period Jitter	T_jitt	-	1.4	1.7	ps	f = 266 MHz, VDD = 3.3V or 2.5V		
		-	1.4	1.7	ps	f = 312.5 MHz, VDD = 3.3V or 2.5V		
		-	1.2	1.7	ps	f = 622.08 MHz, VDD = 3.3V or 2.5V		
RMS Phase Jitter (random)	T_phj	-	0.6	0.85	ps	f = 312.5 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdds		

Pin Description

Pin	Мар	Functionality				
	OE	Input	H or Open: specified frequency output L: output is high impedance			
1	ST	Input	H or Open: specified frequency output L: Device goes to sleep mode. Supply current reduces to I_std.			
2	NC	NA	No Connect; Leave it floating or connect to GND for better heat dissipation			
3	GND	Power	VDD Power Supply Ground			
4	OUT+	Output	Oscillator output			
5	OUT-	Output	Complementary oscillator output			
6	VDD	Power Power supply voltage				



Absolute Maximum

Attempted operation outside the absolute maximum ratings of the part may cause permanent damage to the part. Actual performance of the IC is only guaranteed within the operational specifications, not at absolute maximum ratings.

Parameter	Min.	Max.	Unit
Storage Temperature	-65	150	°C
VDD	-0.5	4	V
Electrostatic Discharge (HBM)	-	2000	V
Soldering Temperature (follow standard Pb free soldering guidelines)	-	260	°C

Thermal Consideration

Package	θJA, 4 Layer Board (°C/W)	θJC, Bottom (°C/W)
7050, 6-pin	142	27
5032, 6-pin	97	20
3225, 6-pin	109	20

Environmental Compliance

Parameter	Condition/Test Method
Mechanical Shock	MIL-STD-883F, Method 2002
Mechanical Vibration	MIL-STD-883F, Method 2007
Temperature Cycle	JESD22, Method A104
Solderability	MIL-STD-883F, Method 2003
Moisture Sensitivity Level	MSL1 @ 260°C



Waveform Diagrams

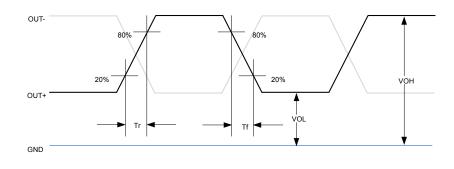


Figure 1(a). LVPECL Voltage Levels per Differential Pin (OUT+/OUT-)

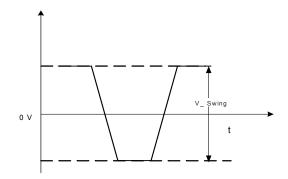


Figure 1(b). LVPECL Voltage Levels Across Differential Pair

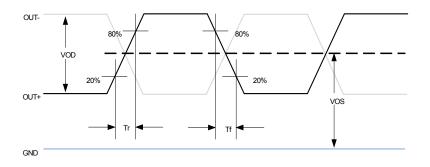


Figure 2. LVDS Voltage Levels per Differential Pin (OUT+/OUT-)



Termination Diagrams

LVPECL:

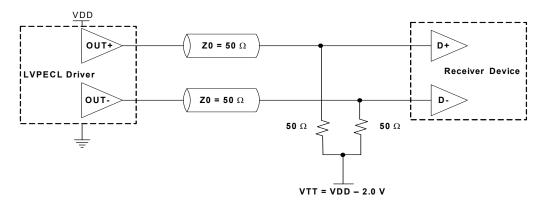


Figure 3. LVPECL Typical Termination

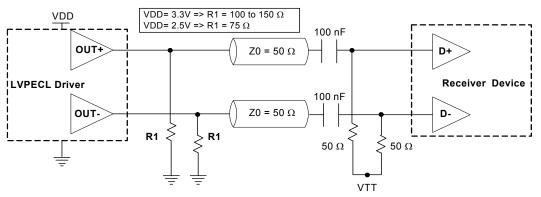


Figure 4. LVPECL AC Coupled Termination

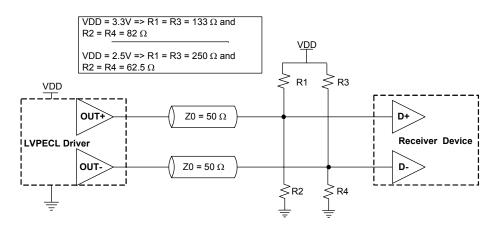


Figure 5. LVPECL with Thevenin Typical Termination

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LVDS:

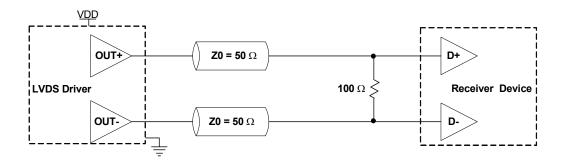


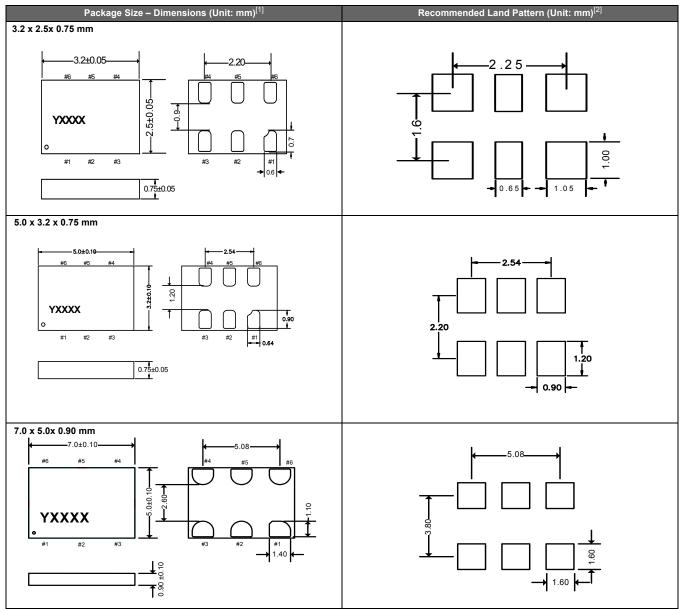
Figure 6. LVDS Single Termination (Load Terminated)

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Dimensions and Patterns



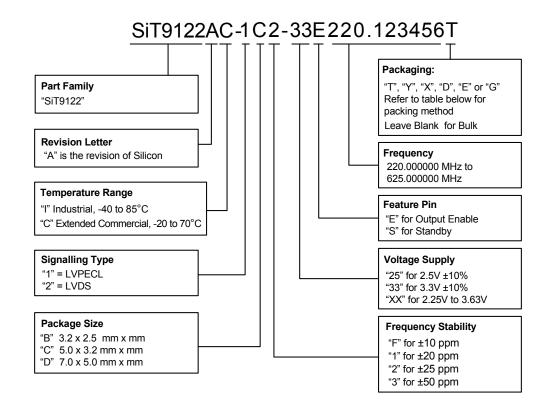
Notes:

1. Top Marking: Y denotes manufacturing origin and XXXX denotes manufacturing lot number. The value of "Y" will depend on the assembly location of the device.

2. A capacitor of value 0.1 μ F between Vdd and GND is recommended.



Ordering Information



Frequencies Not Supported

	Range 1: From 251.000001 MHz to 263.999999 MHz
ĺ	Range 2: From 314.000001 MHz to 422.999999 MHz
	Range 3: From 502.000001 MHz to 527.999999 MHz

Ordering Codes for Supported Tape & Reel Packing Method

Device Size	8 mm T&R (3ku)	8 mm T&R (1ku)	8 mm T&R (250u)	12 mm T&R (3ku)	12 mm T&R (1ku)	12 mm T&R (250u)	16 mm T&R (3ku)	16 mm T&R (1ku)	16 mm T&R (250u)
7.0 x 5.0 mm	-	-	-	-	-	_	Т	Y	Х
5.0 x 3.2 mm	-	-	-	Т	Y	Х	-	_	-
3.2 x 2.5 mm	D	E	G	Т	Y	Х	-	-	-



Revision History

Version	Release Date	Change Summary
1.01	2/20/13	Original
1.02	12/3/13	Added input specifications, LVPECL/LVDS waveforms, packaging T&R options
1.03	2/6/14	Added 8mm T&R option and ±10 ppm
1.04	7/23/14	Include Thermal Consideration Table
1.05	10/6/14	Modified Thermal Consideration values

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